

H5N2503P

Silicon N Channel MOS FET
High Speed Power Switching

HITACHI

ADE-208-1374A (Z)

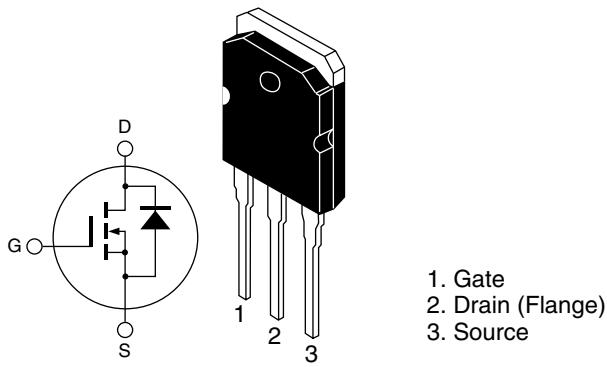
2nd. Edition
Jun. 2002

Features

- Low on-resistance: $R_{DS(on)} = 0.04 \Omega$ typ.
- Low leakage current: $I_{DSS} = 1 \mu\text{A}$ max (at $V_{DS} = 250 \text{ V}$)
- High speed switching: $t_f = 190 \text{ ns}$ typ (at $V_{GS} = 10 \text{ V}$, $V_{DD} = 125 \text{ V}$, $I_D = 25 \text{ A}$)
- Low gate charge: $Q_g = 140 \text{ nC}$ typ (at $V_{DD} = 200 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 50 \text{ A}$)
- Avalanche ratings

Outline

TO-3P



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	250	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	50	A
Drain peak current	I _D (pulse) ^{Note1}	200	A
Body-drain diode reverse drain current	I _{DR}	50	A
Body-drain diode reverse drain peak current	I _{DR} (pulse) ^{Note1}	200	A
Avalanche current	I _{AP} ^{Note3}	50	A
Channel dissipation	Pch ^{Note2}	150	W
Channel to case Thermal Impedance	θ ch-c	0.833	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW ≤ 10 µs, duty cycle ≤ 1%

2. Value at Tc = 25°C

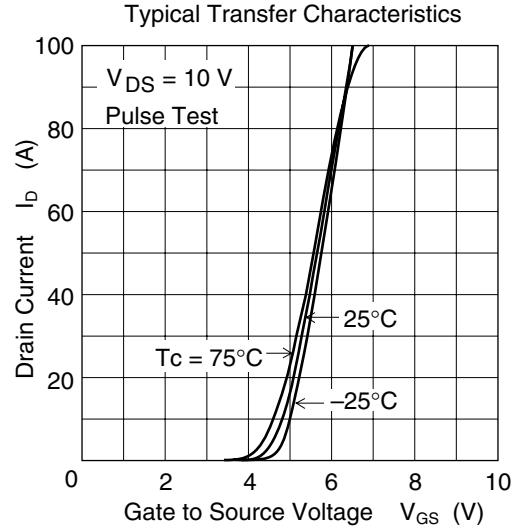
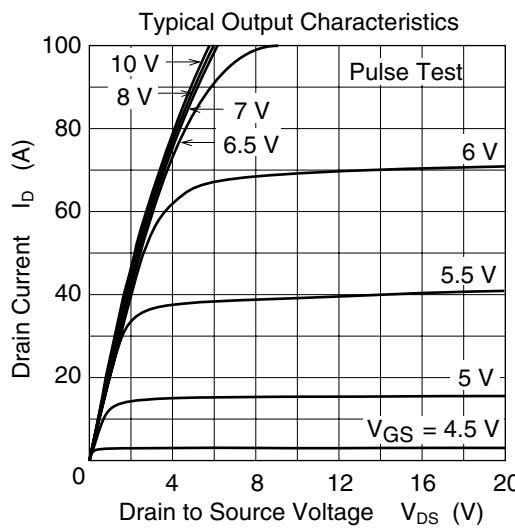
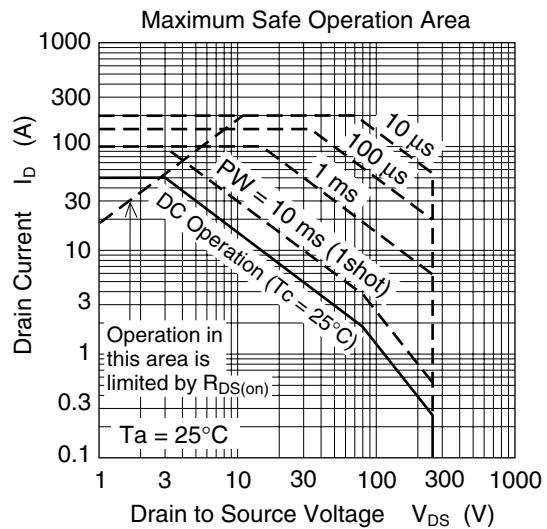
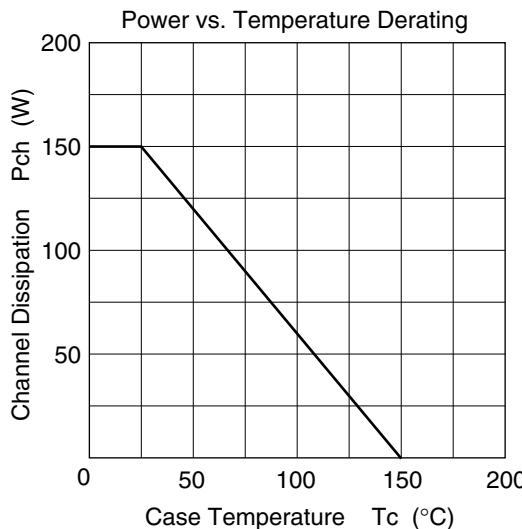
3. Tch ≤ 150°C

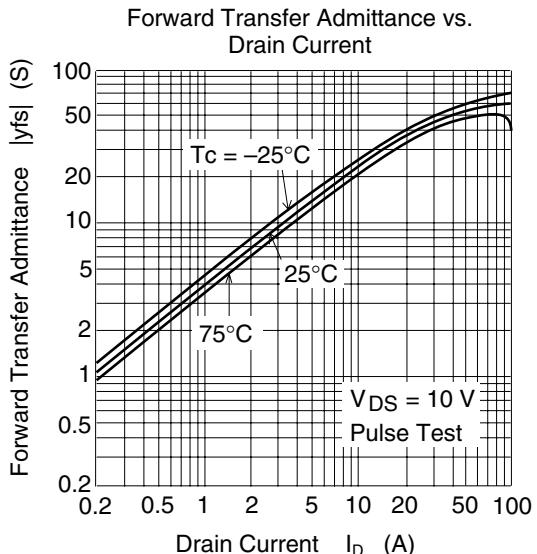
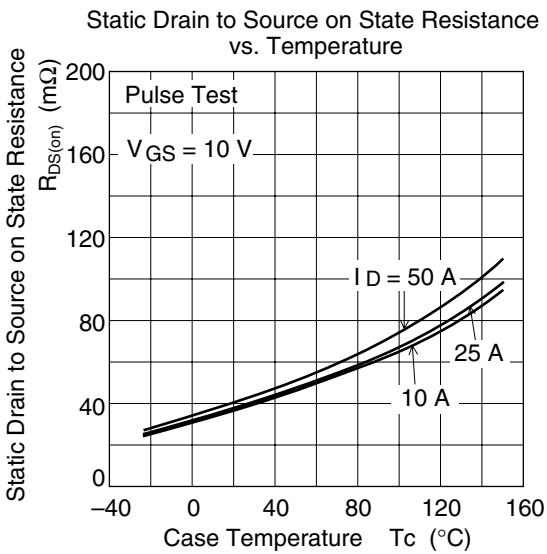
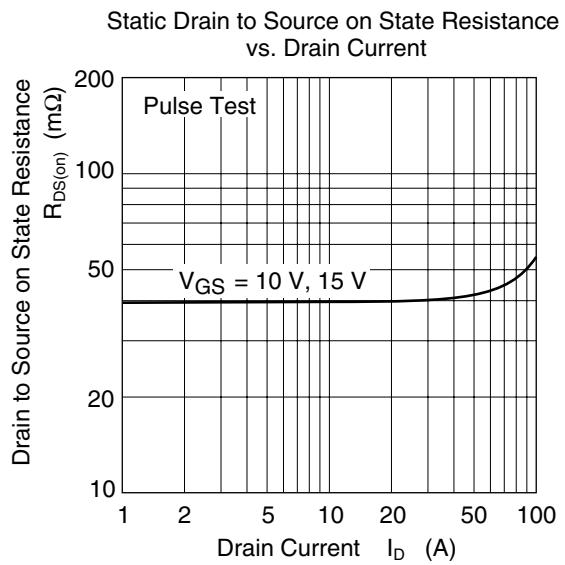
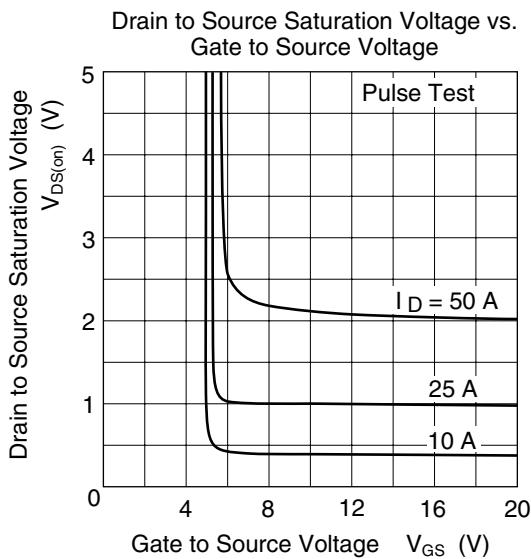
Electrical Characteristics (Ta = 25°C)

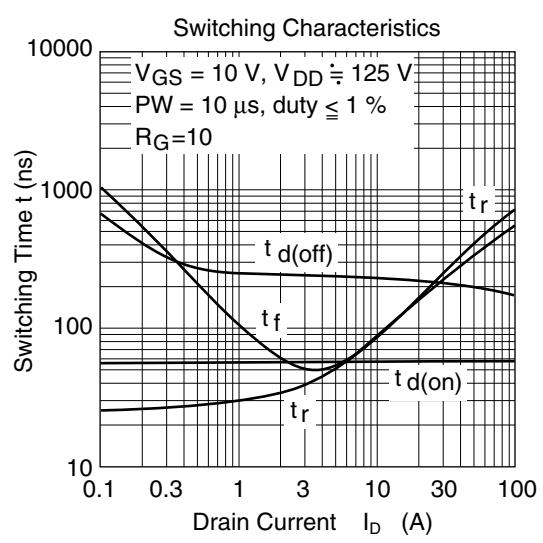
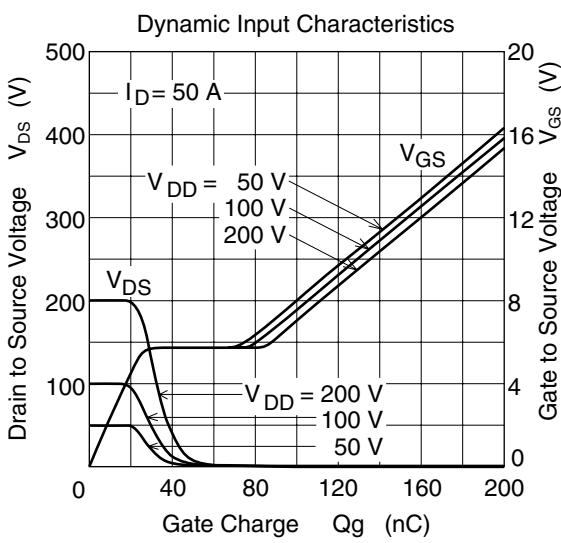
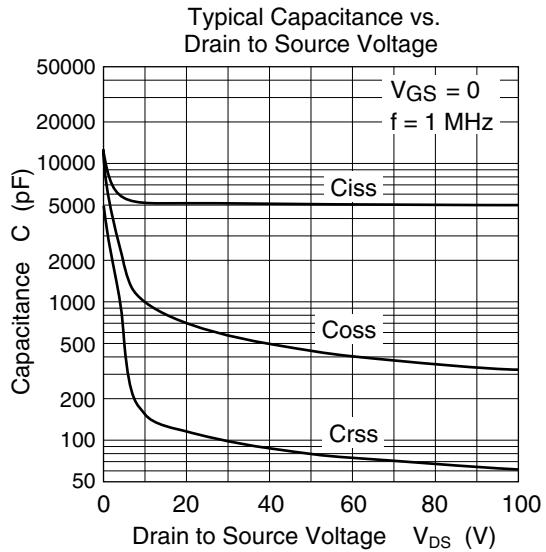
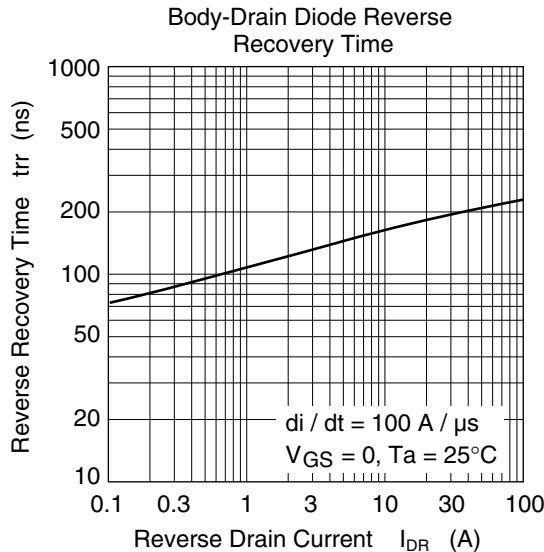
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	250	—	—	V	I _D = 10 mA, V _{GS} = 0
Gate to source leak current	I _{GSS}	—	—	±0.1	µA	V _{GS} = ±30 V, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	—	—	1	µA	V _{DS} = 250 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS(off)}	3.0	—	4.0	V	V _{DS} = 10 V, I _D = 1 mA
Static drain to source on state resistance	R _{DS(on)}	—	0.040	0.055	Ω	I _D = 25 A, V _{GS} = 10 V ^{Note4}
Forward transfer admittance	y _{fs}	25	40	—	S	I _D = 25 A, V _{DS} = 10 V ^{Note4}
Input capacitance	C _{iss}	—	5150	—	pF	V _{DS} = 25 V
Output capacitance	C _{oss}	—	620	—	pF	V _{GS} = 0
Reverse transfer capacitance	C _{rss}	—	105	—	pF	f = 1 MHz
Turn-on delay time	t _{d(on)}	—	58	—	ns	I _D = 25 A
Rise time	t _r	—	210	—	ns	V _{GS} = 10 V
Turn-off delay time	t _{d(off)}	—	220	—	ns	R _L = 5 Ω
Fall time	t _f	—	190	—	ns	R _g = 10 Ω
Total gate charge	Q _g	—	140	—	nC	V _{DD} = 200 V
Gate to source charge	Q _{gs}	—	25	—	nC	V _{GS} = 10 V
Gate to drain charge	Q _{gd}	—	60	—	nC	I _D = 50 A
Body-drain diode forward voltage	V _{DF}	—	1.0	1.5	V	I _F = 50 A, V _{GS} = 0
Bidy-drain diode reverse recovery time	t _{rr}	—	210	—	ns	I _F = 50 A, V _{GS} = 0
Body-drain diode reverse recovery charge	Q _{rr}	—	1.8	—	µC	dI _F /dt = 100 A/µs

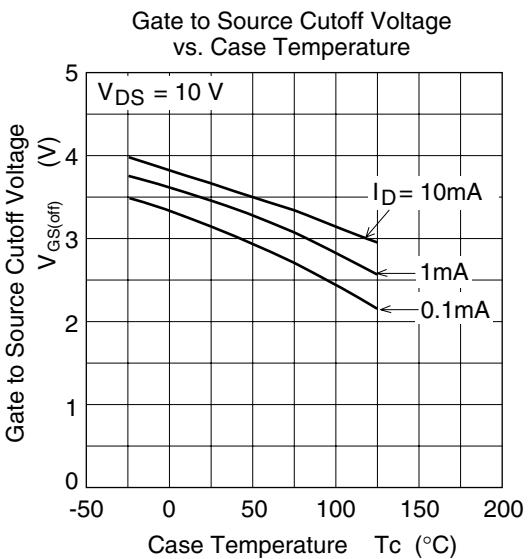
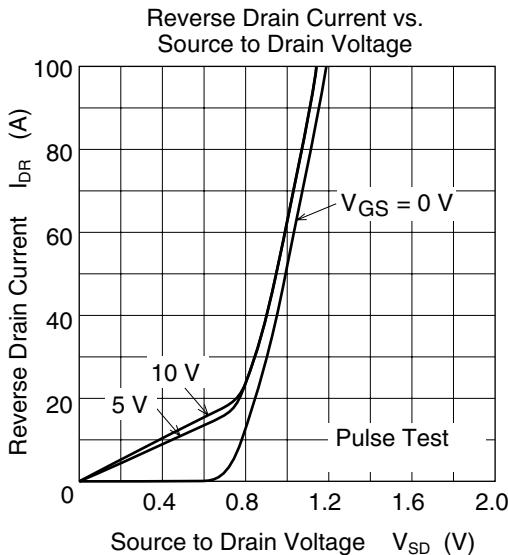
Notes: 4. Pulse test

Main Characteristics

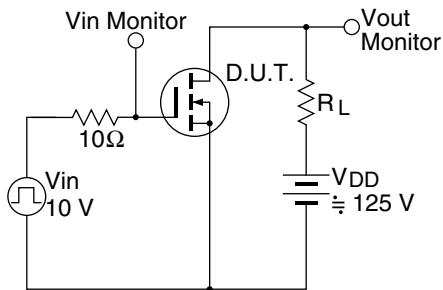




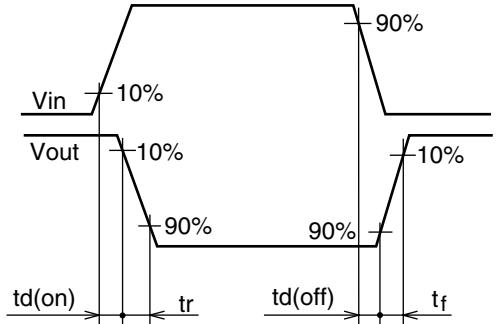




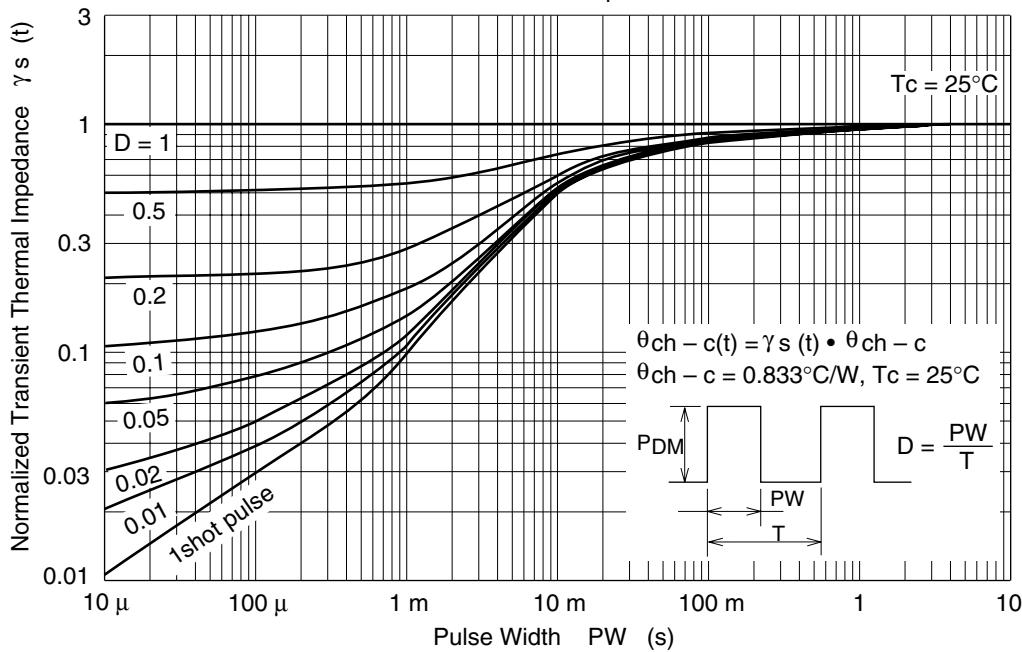
Switching Time Test Circuit



Waveform



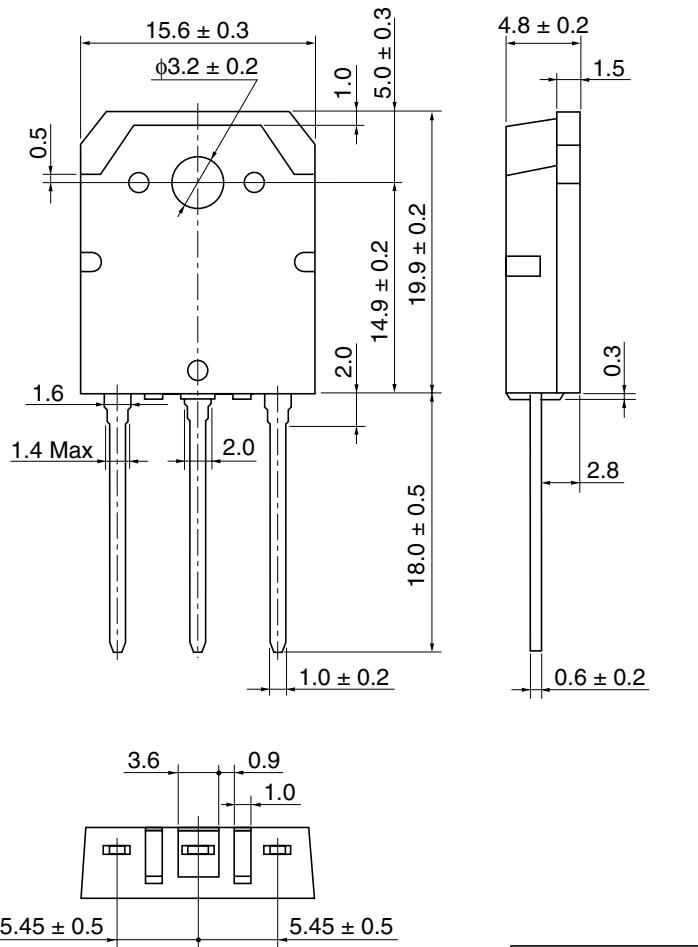
Normalized Transient Thermal Impedance vs. Pulse Width



Package Dimensions

As of January, 2002

Unit: mm



Hitachi Code	TO-3P
JEDEC	—
JEITA	Conforms
Mass (reference value)	5.0 g

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